General Description

The MAX9000 family features the combination of a highspeed operational amplifier, a 185ns comparator, and a precision 1.230V reference. These devices operate from a single +2.5V to +5.5V supply and draw less than 500 μ A of quiescent current. The MAX9001/MAX9004 feature a shutdown mode that reduces supply current to 2 μ A and puts the outputs into a high-impedance state, making them ideal for portable and battery-powered applications.

The amplifiers in the MAX9000/MAX9001/MAX9002 are unity-gain stable with a 1.25MHz gain-bandwidth product, while the amplifiers in the MAX9003/MAX9004/MAX9005 are stable for closed-loop gains of +10V/V or greater with an 8MHz gain-bandwidth product. The input commonmode voltage extends from 150mV below the negative supply to within 1.2V of the positive supply for the amplifier, and to within 1.1V for the comparator. The amplifier and comparator outputs can swing Rail-to-Rail[®] and deliver up to ±2.5mA and ±4.0mA, respectively, to an external load while maintaining excellent DC accuracy. The unique design of the comparator output stage substantially reduces switching current during output transitions, virtually eliminating power-supply glitches.

The comparator's ± 2 mV of built-in hysteresis provides noise immunity and prevents oscillations even with a slow-moving input signal. The MAX9000/MAX9001/ MAX9003/MAX9004 have an internal 1.230V $\pm 1\%$ precision reference with a low 8ppm/°C temperature coefficient that can sink or source up to 1mA. The amplifier and reference are stable with capacitive loads up to 250pF and 100nF, respectively. The comparator's inverting input is internally connected to the reference output in the MAX9000/MAX9003.

Applications

Single-Supply Zero-Crossing Detector Instruments, Terminals, and Bar-Code Readers Keyless Entry Photodiode Preamps Smart Card Readers Infrared Receivers for Remote Controls Sensor Signal Detection

_Features

- Op Amp + Comparator + Reference in Space-Saving µMAX Package
- + +2.5V to +5.5V Single-Supply Voltage Range
- 340µA Supply Current (MAX9002/MAX9005)
- Unity-Gain Stable (GBW = 1.25MHz) and Decompensated (Ay ≥ 10V/V, GBW = 8MHz) Options
- Op-Amp/Comparator Outputs Swing Rail-to-Rail
- Ground-Sensing Inputs for Both Op Amp and Comparator
- Op Amp Stable with Capacitive Loads up to 250pF
- Internal ±2mV Comparator Hysteresis
- Fast 185ns Propagation-Delay Comparator
- No Phase Reversal for Overdriven Inputs (Both Op Amp and Comparator)
- Internal 1.230V Precision Reference (MAX9000/ MAX9001/MAX9003/MAX9004) ±1% Initial Accuracy Low 8ppm/°C Temperature Drift Sink or Source up to 1mA Stable for Capacitive Loads up to 100nF

Ordering Information

PART	TEMP. RANGE	PIN-PACKAGE
MAX9000EUA	-40°C to +85°C	8 µMAX
MAX9000ESA	-40°C to +85°C	8 SO
MAX9001EUB	-40°C to +85°C	10 µMAX
MAX9001ESD	-40°C to +85°C	14 SO

Ordering Information continued at end of data sheet.

Pin Configurations and Typical Operating Circuit appear at end of data sheet.

Rail-to-Rail is a registered trademark of Nippon Motorola, Ltd.

_Selector Guide

				0	elector ourde
PART	INTERNAL PRECISION REFERENCE	OP-AMP GAIN STABILITY (V/V)	SHUTDOWN	OP-AMP GAIN BANDWIDTH (MHz)	PIN-PACKAGE
MAX9000	Yes	1	No	1.25	8 SO/µMAX
MAX9001	Yes	1	Yes	1.25	10 µMAX, 14 SO
MAX9002	No	1	No	1.25	8 SO/µMAX
MAX9003	Yes	10	No	8	8 SO/µMAX
MAX9004	Yes	10	Yes	8	10 µMAX, 14 SO
MAX9005	No	10	No	8	8 SO/µMAX

M/X/W

Maxim Integrated Products 1

For free samples & the latest literature: http://www.maxim-ic.com, or phone 1-800-998-8800. For small orders, phone 408-737-7600 ext. 3468.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage (V_{DD} to V_{SS})0.3V to +6V Voltage Inputs (AIN_, CIN_).....(V_{SS} - 0.3V) to (V_{DD} + 0.3V) Output Short-Circuit Duration (AOUT, COUT, REF)...Continuous to either V_{SS} or V_{DD} Continuous Power Dissipation (T_A = +70°C)

JUI III IUUUS FUM	VEL DISSIPATION (TA $= \pm 70$ C)	
8-Pin SO (der	ate 5.88mW/°C above +70°C)	471mW
8-Pin µMAX (c	derate 4.1mW/°C above +70°C)	330mW

10-Pin µMAX (derate 5.6mW/°C above +70°C)	144mW
14-Pin SO (derate 8.3mW/°C above +70°C)	567mW
Operating Temperature Range	
MAX900_E40°C to	+85°C
Maximum Junction Temperature	⊦150°C
Storage Temperature Range65°C to -	
Lead Temperature (soldering, 10sec)	⊦300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{DD} = +2.5V \text{ to } +5.5V, V_{SS} = 0, \overline{SHDN} = V_{DD} (MAX9001/MAX9004 \text{ only}), V_{CM(OP AMP)} = 0, V_{AOUT} = V_{DD} / 2, V_{CM(COMP)} = 0 (for MAX9001/MAX9002/MAX9004/MAX9005), COUT = Iow, IOUT(REF) = 0, TA = T_{MIN} \text{ to } T_{MAX}$, unless otherwise noted. Typical values are at V_{DD} = 5V and T_A = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
Supply Voltage Range	V _{DD}	Guaranteed by PSRR tests		2.5		5.5	V
		MAX9000/MAX9001/	$V_{DD} = 3V$		410	500	
Supply Current	I _{DD}	MAX9003/MAX9004	$V_{DD} = 5V$		450	550	μA
Supply Current	עטי	MAX9002/MAX9005	V _{DD} = 3V		340	425	μA
		WAX 9002/WAX 9003	$V_{DD} = 5V$		375	475	μΑ
Supply Current in Shutdown	ISHDN	MAX9001/MAX9004 ($V_{\overline{SHDN}} = 0$)		2	5	μΑ
Shutdown Input Bias Current	lin(shdn)	MAX9001/MAX9004 (V SHDN = 0	to V _{DD})		1	2.5	μA
Shutdown Logic High	VIH(SHDN)			0.7 x Vde)		V
Shutdown Logic Low	VIL(SHDN)					0.3 x V _{DD}	V
OP AMP	1					I	
Input Offset Voltage	Vos	MAX900_ES_			±0.5	±1.5	mV
Input Offset Voltage Temperature Coefficient	TCV _{OS}	MAX900_ES_		±1		µV/°C	
Input Bias Current	IBIAS	AIN+, AIN-			±0.05	±2	nA
Input Offset Current		AIN+, AIN-			±0.02	±1	nA
Input Resistance	RIN	Differential or common mode			1000		MΩ
Input Common-Mode Voltage Range	CMVR	Guaranteed by CMRR test		-0.15		V _{DD} - 1.2	V
Common-Mode Rejection Ratio	CMRR	$\begin{array}{l} {\sf MAX900_ES_,\ (V_{SS}-0.15V) \le V_{C}} \\ {\sf V_{DD}=5.5V} \end{array}$	72	96		dB	
Power-Supply Rejection Ratio	PSRR	V _{DD} = 2.5V to 5.5V	74	100		dB	
Output Resistance		$A_V = 1V/V$			0.01		Ω
Output Short-Circuit		Shorted to V _{SS}		10		mA	
Current		Shorted to V _{DD}			65		111/A
Disabled Mode Output Leakage	IOUT (DISABLED)	$V_{\overline{SHDN}} \leq (0.3V \times V_{DD}), V_{AOUT} =$	0 to V _{DD}		±0.01	±1	μΑ



ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DD} = +2.5V \text{ to } +5.5V, V_{SS} = 0, \overline{SHDN} = V_{DD} \text{ (MAX9001/MAX9004 only)}, V_{CM(OP AMP)} = 0, V_{AOUT} = V_{DD} / 2, V_{CM(COMP)} = 0 \text{ (for MAX9001/MAX9002/MAX9004/MAX9005)}, COUT = Iow, I_{OUT(REF)} = 0, T_A = T_{MIN} \text{ to } T_{MAX}, unless otherwise noted. Typical values are at V_{DD} = 5V and T_A = +25°C.)$

PARAMETER	SYMBOL		COND	ITIONS		MIN	TYP	MAX	UNITS
			VAOUT = 0.	05V to 2.45V,	$R_L = 100 k\Omega$	94	125		
		$V_{DD} = 2.5V + V_{AOUT} = 0.2V \text{ to } 2.3V, \text{ RL} = 1k\Omega$		= 1kΩ	84	115			
Large-Signal Voltage Gain	Avol	VAOUT =		05V to 5.4V, F	$R_L = 100 k\Omega$	94	120		dB
		V _{DD} = 5.5V	VAOUT = 0.	25V to 5.2V, F	$R_L = 1k\Omega$	86	106		
				D 1001.0	Vdd - Voh		1	5	
	.,,		1 10	$R_L = 100 k\Omega$	Vol		1	5	-
Output Voltage Swing	Vol / Voh	IVAIN+ - VA	_{IN-} ≥ 10mV	D (1) 0	Vdd - Voh		140	250	- mV
				$R_L = 1k\Omega$	Vol		60	100	-
		MAX9000/N	/AX9001/MA	X9002			1.25		
Gain-Bandwidth Product	GBW	MAX9003/N	/AX9004/MA	X9005			8		- MHz
		MAX9000/N	/AX9001/MA	X9002			75		
Phase Margin		MAX9003/N	/AX9004/MA	X9005			80		degrees
		MAX9000/N	/AX9001/MA	X9002			30		
Gain Margin		MAX9003/N	/AX9004/MA	X9005			40	- dB	
Total Harmonic Distortion		f = 10kHz,		MAX9000/N MAX9002 (A			0.009		
plus Noise	THD+N	V _{AOUT} = 2Vp-p, V _{DD} = 5V		MAX9003/N MAX9005 (A	/AX9004/ A _V = 10V/V)	0.028			- %
		R VDD = 5V, VAOUT = 4V step		MAX9000/MAX9001/ MAX9002 (A _V = 1V/V)			0.85		
Slew Rate	SR			MAX9003/MAX9004/ MAX9005 (Av = 10V/V)			6.0		- V/µs
Cottling Time to within 0.010/		V _{DD} = 5V,		MAX9000/N MAX9002 (J			6.9		
Settling Time to within 0.01%		Vaout = 4\	/ step	MAX9003/N MAX9005 (J	/IAX9004/ A _V = 10V/V)		2.1		- µs
Input Capacitance	CIN						2.5		pF
Input Noise Voltage Density	VNOISE	f = 10kHz					36		nV/√Hz
Input Noise Current Density	INOISE	f = 10kHz					1		fA/√Hz
Shutdown Delay Time							0.2		μs
Enable Delay Time							2		μs
Power-On Time							2		μs
Capacitive Load Stability	CLOSE	MAX9000/MAX9001/MAX9002 (A _V = 1V/V) MAX9003/MAX9004/MAX9005 (A _V = 10V/V)			1V/V)		250		p.F
Capacitive-Load Stability	CLOAD				10V/V)		250		- pF
COMPARATOR					L				
Input Offset Voltage	Vos	MAX900_E	S_ (Notes 1, 2	2)			±1	±2	mV
Input Offset Voltage Temperature Coefficient	TCVos	MAX900_E	S_				±1		µV/°C
Input-Referred Hysteresis		V _{DD} = 5V (I	Notes 2, 3)				4	7	mV



ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DD} = +2.5V \text{ to } +5.5V, V_{SS} = 0, \overline{SHDN} = V_{DD} \text{ (MAX9001/MAX9004 only)}, V_{CM(OP AMP)} = 0, V_{AOUT} = V_{DD} / 2, V_{CM(COMP)} = 0 \text{ (for MAX9001/MAX9002/MAX9004/MAX9005)}, COUT = Iow, I_{OUT(REF)} = 0, T_A = T_{MIN} \text{ to } T_{MAX}, unless otherwise noted. Typical values are at V_{DD} = 5V and T_A = +25°C.)$

PARAMETER	SYMBOL		CONDITIONS		MIN	TYP	MAX	UNITS	
Input Bias Current	IBIAS						8	80	nA
Input Offset Current	los	MAX9001/MAX9002/MAX9004/MAX9005				±2	±15	nA	
Common-Mode Voltage Range	Vсм	Guaranteed by	CMRR te	st		V _{SS} - 0.15		V _{DD} - 1.1	V
Common-Mode Rejection Ratio	CMRR	$\begin{array}{l} MAX9001/MAX\\ 0.15V \leq V_{CM} \leq \end{array}$				72	100		dB
Power-Supply Rejection Ratio	PSRR	VDD = 2.5V to 5	5.5V			72	100		dB
Output Voltage Swing	Vol/Voн	(V _{CIN+} - V _{CIN-}) ≥ 20mV	Vdd - Vo	ЭН	ISOURCE = 10μA ISOURCE = 4mA ISINK = 10μA ISINK = 4mA	5 400		5 400	mV
Output Short-Circuit Current			l				55		mA
Disabled Mode Output Leakage	lout (DISABLED)	V SHDN ≤(0.3V	V SHDN ≤ (0.3V x V _{DD}), V _{COUT} = 0 to V _{DD}			±0.01	±1	μΑ	
Propagation Delay	tpD+, tpD-	Vod = 25mV, F	$R_{L} = 10k\Omega$, CL =	15pF (Note 4)		185		ns
Rise/Fall Time	t _R , t _F	$V_{DD} = 5V, R_L =$	= 10k Ω , CL	_ = 15	oF (Note 5)		10		ns
Shutdown Delay Time							100		ns
Enable Delay Time							100		ns
Power-On Time							100		ns
VOLTAGE REFERENCE (MAX9000/MA	X9001/MAX9003	/MAX9004	4)					
Output Voltage	VREF	MAX900_ES_,	$V_{DD} = 5V$,	$T_A = \cdot$	-25°C	1.218	1.230	1.242	V
Output Voltage Temperature Coefficient	TCV _{REF}						8		ppm/°C
Line Regulation		VDD = 2.5V to 5	5.5V				20	250	μV/V
Load Degulation		$V_{DD} = 5V$,		Sour	cing		0.15	0.8	mV/mA
Load Regulation		$I_{OUT} = 0$ to 1m.	A	Sink	ng		0.6	2.0	mV/mA
Output Short-Circuit		Shorted to V _{SS}					6		mA
Current		Shorted to V _{DD}					10		
Disabled Mode Output Leakage		$V_{\overline{SHDN}} \le (0.3V \times V_{DD})$, $V_{REF} = 0$ to V_{DD}			±0.01	±1	μA		
Output Noise		0.1Hz to 10Hz				20		μVp-р	
Shutdown Delay Time							1		μs
Enable Delay Time		$R_L = 100 k\Omega$ to	Vss, Vref	within	1%		16		μs
Power-On Time		$R_L = 100 k\Omega$ to	Vss, Vref	within	1%		16		μs
Capacitive Load Stability							0 to 100		nF

Note 1: Comparator Input Offset is defined as the center of the input-referred hysteresis zone.

Note 2: Measured at $V_{CM(COMP)} = 0$ for the MAX9001/MAX9002/MAX9004/MAX9005; or $V_{CM(COMP)} = V_{REF}$ for the MAX9000/MAX9003.

Note 3: Input-referred hysteresis is defined as the difference of the trip points required to change comparator output states.

Note 4: V_{OD} is the overdrive that is beyond the offset and hysteresis-determined trip points.

Note 5: Rise and fall times are measured between 10% and 90% at COUT.



_Typical Operating Characteristics

(V_{DD} = +5V, V_{SS} = 0, V_{CM} (op amp) = 0, SHDN = V_{DD}, COUT = low, R_L = \sim T_A = +25°C, unless otherwise noted.)



_Typical Operating Characteristics (continued)

(V_{DD} = +5V, V_{SS} = 0, V_{CM} (op amp) = 0, SHDN = V_{DD}, COUT = Iow, R_L = ∞ T_A = +25°C, unless otherwise noted.)



 $R_L = 2k\Omega$

300

OUTPUT VOLTAGE FROM EITHER SUPPLY (mV)

400

500 600

110

100

0

100 200

OP-AMP COMMON-MODE REJECTION RATIO



OP-AMP LARGE-SIGNAL GAIN vs. TEMPERATURE



OP-AMP LARGE-SIGNAL GAIN vs. TEMPERATURE





Typical Operating Characteristics (continued)



7



MAX9000-MAX9005

8

Typical Operating Characteristics (continued)

 $(V_{DD} = +5V, V_{SS} = 0, V_{CM} \text{ (op amp)} = 0, \overline{SHDN} = V_{DD}, COUT = Iow, R_L = 9 T_A = +25^{\circ}C, unless otherwise noted.)$



/N/XI/N







(V_{DD} = +5V, V_{SS} = 0, V_{CM} (op amp) = 0, SHDN = V_{DD}, COUT = low, R_L = ∞ T_A = +25°C, unless otherwise noted.)

VREF OUTPUT VOLTAGE CHANGE vs. LOAD CURRENT 4 VREF OUTPUT VOLTAGE CHANGE (mV) 3 SINKING 2 1 SOURCING 0 -1 -2 -1.5 -1.0 -2.0 -0.5 0 0.5 1.0 1.5 2.0 LOAD CURRENT (mA)





VREF LINE-TRANSIENT RESPONSE



VREF 0.1Hz to 10Hz VOLTAGE NOISE



1sec/div

MAX9000/MAX9001/MAX9002

OP-AMP SMALL-SIGNAL TRANSIENT

RESPONSE WITH CLOAD

1µs/div

VIN

 $A_V = +1$

 $C_L = 270 pF$

COMPARATOR PROPAGATION DELAY



100ns/div

MAX9003/MAX9004/MAX9005







Typical Operating Characteristics (continued)

(V_{DD} = +5V, V_{SS} = 0, V_{CM} (op amp) = 0, SHDN = V_{DD}, COUT = low, R_L = ∞ T_A = +25°C, unless otherwise noted.)



_Pin Description

	Р	IN			
MAX9000/	MAX9002/	MAX9001/MAX9004		NAME	FUNCTION
MAX9003	MAX9005	10 µMAX	14 SO		
_	_	1	2	SHDN	Shutdown Logic Input
1	1	2	3	AOUT	Op-Amp Output
2	2	3	4	AIN-	Inverting Op-Amp Input
3	3	4	5	AIN+	Noninverting Op-Amp Input
4	4	5	6	V _{SS}	Negative Supply or Ground
5	—	6	9	REF	Internal Reference Output
_	5	7	10	CIN-	Inverting Comparator Input
6	6	8	11	CIN+	Noninverting Comparator Input
7	7	9	12	COUT	Comparator Output
8	8	10	13	Vdd	Positive Supply
_	_	_	1, 7, 8, 14	N.C.	No Connection. Not internally connected.





Figure 1. MAX9000–MAX90005 Functional Diagrams

Detailed Description

The MAX9001-MAX9005 are combinations of a highspeed operational amplifier, a 185ns comparator, and a 1%-accurate, 8ppm/°C, 1.230V reference. The devices are offered in space-saving 8-pin and 10-pin µMAX packages. The comparator's inverting input is internally connected to the reference output in the MAX9000/MAX9003. The MAX9002/MAX9005 do not have an internal reference, but the inverting input of the comparator is available externally. The MAX9001/MAX9004 include both the inverting input and the reference output. The MAX9000/ MAX9001/MAX9003/MAX9004 typically consume only 410µA of quiescent current, while the MAX9002/ MAX9004 typically consume 340µA. These low-power, Rail-to-Rail devices provide excellent AC and DC performance and are ideally suited to operate from a single supply. The MAX9001/MAX9004 feature a shutdown mode that sets the outputs in a high-impedance state and reduces the supply current to 2µA, making these devices ideal for portable and battery-powered systems.

Op Amp

The op amps in the MAX9000/MAX9001/MAX9002 are unity-gain stable with a gain-bandwidth product of 1.25MHz and a slew rate of 0.85V/µs. The amplifiers in the MAX9003/MAX9004/MAX9005 are stable at closed-loop gains greater than or equal to 10V/V, with a gain-bandwidth product of 8MHz and a slew rate of 6.0V/µs.

The common-mode input voltage range extends from 150mV below the negative rail to within 1.2V of the positive rail. The amplifier output does not undergo phase reversal when the common-mode input range is exceeded, and the input impedance is relatively constant for input voltages within both supply rails. The MOS differential inputs of the amplifiers feature extremely high input impedance and ultra-low input bias currents. The CMOS output stage achieves true rail-to-rail operation; the outputs swing to within a few millivolts of the supply rails, thus extending the dynamic range. A proprietary design achieves high open-loop gain, enabling these devices to operate at low quiescent currents yet maintain excellent DC and AC characteristics under various load conditions. These devices have been designed to maintain low offset voltage over the entire operating-temperature, commonmode, and supply-voltage ranges.



Comparator

The common-mode input range extends from 150mV below the negative rail to within 1.1V of the positive rail. The bipolar differential inputs of the comparator feature high input impedance and low input bias currents. The comparators are designed to maintain low offset voltage over the entire operating-temperature, common-mode, and supply-voltage ranges. In the MAX9000/MAX9003, the comparator's inverting input is internally connected to the reference output.

The CMOS output stage achieves true rail-to-rail operation; the outputs swing to within a few millivolts of the supply rails. The comparator's propagation delay is 185ns and is a function of the overdrive (see *Typical Operating Characteristics*). TTL/CMOS compatibility is maintained even with a ±4mA output load. A proprietary design of the output stage substantially reduces the cross-conduction current during output transitions, thereby minimizing power-supply glitches typical of most comparators. In addition, the comparator's ±2mV of built-in hysteresis provides noise immunity and prevents unstable outputs even with slow-moving input signals.

Voltage Reference

The 1%-accurate, precision 1.230V internal bandgap reference in the MAX9000/MAX9001/MAX9003/ MAX9004 achieves an 8ppm/°C temperature coefficient (tempco). The reference can sink or source 1mA of load current with excellent load regulation. The output typically changes only 60μ V for a 3V change in input voltage (line regulation). The reference is stable for capacitive loads up to 100nF.

Applications Information

The MAX9000–MAX9005 offer excellent performance and low power consumption, and are available in space-saving μ MAX packages. The following section provides some practical application guidelines.

Bypassing and Layout

The MAX9000–MAX9005 operate from a +2.5V to +5.5V single supply or from \pm 1.25V to \pm 2.75V dual supplies. (In the MAX9000/MAX9001/MAX9003/MAX9004, the reference voltage is referred to as V_{SS}.). For single-supply operation, bypass the power supply with a 0.1µF capacitor. For dual supplies, bypass each supply to ground. Bypass with capacitors as close as possible to the device to minimize lead inductance and noise. Use a low-inductance ground plane if possible. A printed circuit board with a ground plane is recommended. Avoid using wire-wrap boards, breadboards, or IC sockets. For heavy loads at the comparator's and/or

amplifier's output, add a $1\mu F$ to $10\mu F$ power-supply bypass capacitor.

The device has a high degree of isolation between the various blocks. To maintain isolation, careful layout is required. Take special precautions to avoid crossing signal traces, especially from the outputs to the inputs. For sensitive applications, shielding might be required. In addition, stray capacitance may affect the stability and frequency response of the amplifier. Decrease stray capacitance by minimizing lead lengths in the board layout, as well as placing external components as close to the device as possible.

Op-Amp Frequency Stability

Driving large capacitive loads can cause instability in most low-power, rail-to-rail output amplifiers. These amplifiers are stable with capacitive loads up to 250pF in their minimum gain configuration. Stability with higher capacitive loads can be improved by adding an isolation resistor in series with the op-amp output, as shown in Figure 2. This resistor improves the circuit's phase margin by isolating the load capacitor from the amplifier's output. Figures 3 and 4 show the response of the amplifier with and without an isolation resistor, respectively.

The total capacitance at the op amp's inputs (input capacitance + stray capacitance) along with large-value feedback resistors can cause additional poles within the amplifier's bandwidth, thus degrading the phase margin. To compensate for this effect, place a 2pF to 10pF capacitor across the feedback resistor, as shown in Figure 5.



Figure 2. Isolation Resistors to Drive Capacitive Loads



Figure 3. MAX9000/MAX9001/MAX9002 Op-Amp Small-Signal Transient Response with Capacitive Load (C_L = 510pF) and Isolation Resistor (R_{ISO} = 91 Ω)



Figure 5. Compensation for Input Capacitance

Reference Bypassing

While the internal reference is stable with capacitive loads up to 100nF, it does not require an output capacitor for stability. However, in applications where the load or the supply could experience large step changes, an output capacitor reduces the amount of overshoot and improves the circuit's transient response.

Comparator Input Stage

The comparator's input bias current is typically 8nA. To reduce the offset error caused by the bias current flowing through the external source impedance, match the effective impedance seen by each input. High source impedance together with the comparator's input capacitance can increase the propagation delay through the



Figure 4. MAX9000/MAX9001/MAX9002 Op-Amp Small-Signal Transient Response with Capacitive Load ($C_L = 510$ pF) and No Isolation Resistor



Figure 6. External Hysteresis

comparator. The outputs do not undergo phase reversal when the input common-mode range is exceeded, and the input impedance is relatively constant for input voltages within both supply rails.

Comparator Hysteresis

Built-in ±2mV hysteresis improves the comparator's noise immunity. It prevents unstable outputs with slow-moving or noisy input signals. If additional hysteresis is required, add positive feedback as shown in Figure 6. This configuration increases the hysteresis band to desired levels, but also increases power consumption and slows down the output response.



To add hysteresis, use the following procedure:

Step 1: The device's input bias current can be as high as 80nA. To minimize error due to the input bias, choose a value for R2 of $100k\Omega$ (V_{REF} / R2), which allows a current of 12.33μ A at the upper trip point.

Step 2: Choose the width of the hysteresis band. In this example, choose 20mV for the added external hysteresis (VEHYST = 20mV). Total hysteresis = VEHYST + VIHYST = 24mV.

 $R1 = R2 (V_{EHYST} - 2V_{IHYST}) / (V_{DD} + 2V_{IHYST})$

where IHYST is the device's internal hysteresis.

Step 3: Determine R1. If $V_{DD} = 5V$, then R1 = 319 Ω .

Step 4: Check the hysteresis trip points. The following equation represents the upper trip point $(V_{IN(H)})$:

 $V_{IN(H)} = [(R1 + R2) / R2] (V_{REF} + V_{IHYST}) = 1.238V$

The lower trip point is 24mV lower than upper trip point. $V_{IN(L)} = 1.238V - 0.024V = 1.214V$.

Comparator Propagation Delay

The comparator's propagation delay is a function of the input overdrive voltage. Overdrive voltage is measured from beyond the edge of the offset and hysteresis-determined trip points (see *Typical Operating Characteristics* for a graph of Propagation Delay vs. Input Overdrive). High source impedance coupled with the comparator's input capacitance increases the propagation delay. Large capacitive loads also increase the propagation delay.

Shutdown (SHDN)

Shutdown is active-low enabled. The SHDN input for the MAX9001/MAX9004 can be taken above the posi-



Figure 7. Enable/Disable Response of Op Amp, Comparator, and Reference to SHDN

tive supply without an increase in the SHDN input current, allowing them to be driven from independent logic circuits powered from a different supply voltage. However, the logic threshold voltage requirements must be met for proper operation. If SHDN is left unconnected, the device defaults to the enabled mode through an internal 4M Ω pull-up to VDD. If SHDN is to be left unconnected, take proper care to ensure that no signals are coupled to this pin, as this may cause false triggering.

In shutdown mode, all outputs are set to a high-impedance state and the supply current reduces to 2μ A. Enable times for the op amp, comparator, and reference are 2μ s, 100ns, and 16 μ s, respectively. Shutdown delay times for the op amp, comparator, and reference are 200ns, 100ns, and 1 μ s, respectively (Figure 7).

_Application Circuits

Radio Receiver for Alarms and Detectors

Figure 8's circuit is useful as a front end for RF alarms. An unshielded inductor is used with capacitors C1A, C1B, and C1C in a resonant circuit to provide frequency selectivity. The op amp from a MAX9003 amplifies the signal received. The comparator improves noise immunity, provides a signal-strength threshold, and translates the received signal into a pulse train. The tuned LC circuit in Figure 8 is set for 300kHz. The layout and routing of components for the amplifier should be tight to minimize 60Hz interference and crosstalk from the comparator. Metal shielding is recommended to prevent RFI from the comparator or digital circuitry from exciting the receiving antenna. The transmitting



Figure 8. Radio Receiver Application



antenna can be long parallel wires spaced about 7.2cm apart, with equal but opposite currents. Radio waves from this antenna are detectable when the receiver is brought within close proximity, but cancel out at greater distances.

Infrared Receiver Front End for Remote Controls and Data Links

The circuit in Figure 9 uses the MAX9003 as a PIN photodiode preamplifier and discriminator for an infrared receiver. The op amp is configured as a Delyiannisnoise and eliminates low-frequency interference from sunlight, fluorescent lights, etc. This circuit is applicable for TV remote controls and low-frequency data links up to 200kbps. Carrier frequencies are limited to around 100kHz, as in the example circuit. Component layout and routing for the amplifier should be tight to reduce stray capacitance, 60Hz interference, and RFI from the comparator. Crosstalk from comparator edges distorts the amplifier signal. To minimize this effect, add a lowpass RC filter to the connection from the reference to the op amp's noninverting input.

Signal Conditioning

For incoming signals that require filtering, the internal amplifier provides an opportunity to create an active filter. This may be required for relatively high-speed signals that require adequate filtering of high-speed carrier frequencies, harmonics, and external noise. In addition, the amplifier can be used to amplify the signal prior to digitizing it through the comparator to improve the comparator's overall output response and improve its noise immunity.



Figure 9. Infrared Receiver Application

Pin Configurations



Typical Operating Circuit



MAX9000-MAX9005

Ordering Information (continued)

TEMP. RANGE	PIN-PACKAGE
-40°C to +85°C	8 µMAX
-40°C to +85°C	8 SO
-40°C to +85°C	8 μΜΑΧ
-40°C to +85°C	8 SO
-40°C to +85°C	10 µMAX
-40°C to +85°C	14 SO
-40°C to +85°C	8 μΜΑΧ
-40°C to +85°C	8 SO
	-40°C to +85°C -40°C to +85°C

Chip Information

TRANSISTOR COUNT: 283

Package Information





Package Information (continued)

Package Information (continued)



Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

_____Maxim Integrated Products, 120 San Gabriel Drive, Sunnyvale, CA 94086 408-737-7600

Printed USA

© 1998 Maxim Integrated Products

20

is a registered trademark of Maxim Integrated Products.